

Upcoming: April 17–21 MRS Spring Meeting, MRS; May 15–18 ICNDST & ADC 2006 Joint Conf., MRS; and May 29–June 2 E-MRS-IUMRS-ICEM 06, IUMRS, E-MRS

To list an event in the Calendar, contact J. Meiksin, Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3004 ext. 522; fax 724-779-8313; bulletin@mrs.org.

MRS, A-MRS, B-MRS, C-MRS, E-MRS, MRS-A, MRS-I, MRS-J, MRS-K, MRS-R, MRS-S, MRS-T, M-MRS, or IUMRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.

▼ identifies a new or revised entry this month.

See the January 2006 MRS BULLETIN for March 2006 Calendar entries. For updates, access www.mrs.org.

APRIL 2006

1–2 Northeast Bioengineering Conf., *Easton, PA*. Lafayette College, Ismail Jouny, Acopian Engineering Center, Easton, PA, 18042; 610-330-5414; fax 610-330-5059; e-mail jounyi@lafayette.edu; ww2.lafayette.edu/~nebc2006.

1–5 Experimental Biology 2006 Annual Meeting, *San Francisco, CA*. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings/eb2006.

2–4 Small Fuel Cells for Portable Applications, *Washington, DC*. Knowledge Foundation, 18 Webster Street, Brookline, MA, 02446-4938; (617) 232-7400; fax (617) 232-9171; e-mail custserv@knowledgefoundation.com; www.knowledgefoundation.com.

3–5 Pacific Intl. Conf. on Applications of Lasers and Optics (PICALO 2006), *Melbourne, Australia*. Laser Institute of America, 13501 Ingenuity Drive, Suite 128, Orlando, FL 32826; 407-380-1553; fax 407-380-5588; e-mail bcohen@laserinstitute.org; www.laserinstitute.org/conferences/picalo.

3–7 SPIE—Photonics Europe 2006, *Strasbourg, France*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; spie.org/conferences/calls/06/epe.

4–6 World Copper Conf., *Santiago, Chile*. Marilyn Portner, CRU Events, 31 Mount Pleasant, London WC1X 0AD, United Kingdom, 44-20-7903-2402; e-mail cruevents@crugroup.com; www.cruevents.com.

5–7 Materials Congress 2006, *London, UK*. Lisa Bromley, IOM Communications, 1 Carlton House, London, SW1Y 5DB, UK; 44-20-7451-7302; fax 44-20-7839-2289; e-mail lisa.bromley@iom3.org; www.iom3.org/congress.

6–9 IEEE Intl. Symp. on Biomedical Imaging: From Nano to Macro, *Arlington, VA*. Jelena Kovacevic, Carnegie Mellon University, Dept. of Biomedical Engineering, 5000 Forbes Avenue, Pittsburgh, PA 15213; e-mail jelenak@cmu.edu; www.biomedicalimaging.org.

9–12 ▼ Focus on Microscopy, *Perth, Australia*. David Sampson, University of Western Australia, School of Electrical, Electronic, & Computer Engineering, Optical Engineering Laboratory, M018, 35 Stirling Highway, Crawley, WA 6009, Australia, 8-6488-2317; fax 8-6488-1319; e-mail dsampson@ee.uwa.edu.au; www.focusonmicroscopy.org.

9–14 Frontiers in Boundary Lubricating Films, *Lyon, France*. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6al.html.

10–13 Intl. Conf. on Deformation, Yield and Fracture of Polymers (DYFP2006), *Rolduc Abbey, Netherlands*. Marleen Rieken, Eindhoven University of Technology, P.O. Box 513, NL-5600 MB Eindhoven, Netherlands, 31-40-2472851; fax 31-40-2447355; e-mail DYFP2006@tue.nl; www.dyfp2006.tue.nl.

17–20 Intl. Society of Electrochemistry (ISE) Spring Meeting 2006, *Singapore*. Secretariat ISE Spring 2006 Conference, 1122A Serangoon Road, Singapore, 65-6295-5790; fax 65-6295-5790; e-mail secretariat@ise2006.org; www.ise2006.org.

17–21 2006 MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Drive, Warrendale; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

19–21 ▼ Dalton Discussion 9: Functional Molecular Assemblies, *Manchester, UK*. RSC Conferences, Thomas Graham House, Science Park, Milton Road, Cambridge CB4 0WF, UK, 44-0-1223-432254; fax 44-0-1223-423623; www.rsc.org/ConferencesAndEvents/RSCConferences/DD9.

22–25 ▼ APS April Meeting 2006, *Dallas, TX*. APS, www.aps.org/meet/calendar.cfm.

22–27 49th SVC Annual Technical Conf., *Washington, D.C.* Society of Vacuum Coaters; 505-856-7188; e-mail svcinfo@svc.org; www.svc.org.

23–27 AIChE 2006 Spring National Meeting, *Orlando, FL*. American Institute of Chemical Engineers, 3 Park Avenue, New York, NY 10016-5991; 212-591-7338; fax 212-591-8894; e-mail meetmail@aiche.org; aiche.confex.com/aiche/s06/cfp.epl.

23–27 World Congress on Particle Technology (WCPT5), *Lake Buena Vista, FL*. George Klinzing, University of Pittsburgh, Office of the Provost, 826 Cathedral of Learning, Pittsburgh, PA 15260; 412-624-0784; fax 412-624-4618; e-mail confchair@wcpt5.org; www.erpt.org/wcpt5.

23–28 Intl. Conf. on Mechanics and Mechanical Properties of Non-crystalline Materials I: Amorphous Metals, *Beijing, China*. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6am.html.

24–26 Intl. Brazing and Soldering Conf. (IBSC) *San Antonio, TX*. ASM International Customer Service, 9639 Kinsman Road, Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; customer.service@asminternational.org; www.asminternational.org/ibsc.

24–26 ▼ Intl. Technical Conf. on Diamond, CBN, and their Applications (INTERTECH 2006), *Atlanta, GA*. Industrial Diamond Association of America, P.O. Box 29460, Columbus, OH, 43229; 614-797-2265; fax 614-797-2264; e-mail tkane-ida@insight.rr.com; www.intertechconference.com.

24–28 Integrated Photonics Research and Applications Topical Meeting (IPRA) and Nanophotonics Topical Meeting (NP), *Uncasville, CT*. Optical Society of America, 2010 Massachusetts Ave., NW, Washington, 202-223-8130; fax 202-223-1096; e-mail info@osa.org; www.osa.org/meetings/topicals/ipr_np.

25–26 Joining Plastics 2006, *London, United Kingdom*. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, United Kingdom, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/JoiningPlastics06.

25–27 IMAPS/ACerS Intl. Conf. and Exhibition on Ceramic Interconnect and Ceramic Microsystems Technologies (CICMT), *Denver, CO*. The American Ceramic Society, 735 Ceramic Place, Suite 100, Westerville, OH 43081; 614-890-4700; fax 614-899-6109; e-mail info@ceramics.org; www.cicmt.org.

26–28 TAPPI 2006 Intl. Conf. on Nanotechnology for the Forest Products Industry, *Atlanta, GA*. www.tappi.org/06NANO.

26–29 SFB 2006—Society for Biomaterials Annual Meeting and Exposition, *Pittsburgh, PA*. Rebecca Hanes, Society for Biomaterials, 17000 Commerce Parkway, Suite, Mt. Laurel, 856-439-0826 x3061; fax 856-439-0525; e-mail rhaines@ahint.com; www.biomaterials.org/Meetings/06AnnualMeeting.

30–5 ▼ Gordon Research Conf. on Photosensory Receptors and Signal Transduction, *Barga, Italy*. Roberto Bogomolni, University of California, Santa Cruz, Dept. of Chemistry & Biochemistry, 289 Thimann Lab, 1156 High Street, Santa Cruz, CA, 95064; e-mail bogo@chemistry.ucsc.edu; www.grc.org/programs/2006/photosen.htm.

MAY 2006

1–5 ▼ Intl. Conf. on Metallurgical Coatings and Thin Films (ICMCTF 2006), *San Diego, CA*. Mary Gray, ICMCTF-2003, Suite 136, 14001-C St. Germain Drive, Centreville, VA, 20121; 703-266-3287; fax 703-968-8877; e-mail icmctf@mindspring.com; www2.avs.org/conferences/icmctf.

1–5 ▼ Intl. Conf. on Quantum Dots (QD2006), *Chamonix-Mont Blanc, France*. K. Kheng, e-mail info.qd2006@ujf-grenoble.fr; www-lsp.ujf-grenoble.fr/qd2006.

3–6 Intl. Conf. on High Performance Structures and Materials, *Ostend, Belgium*. Wessex Institute of Technology Conferences, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK; 44-0-238-029-3223; fax 44-0-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk/conferences/2006/hpsm06.

7–11 Intl. Conf. on Shape Memory and Superelastic Technologies (SMST), *Pacific Grove, CA*. ASM International Customer Service, 9639 Kinsman Road, Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; customer.service@asminternational.org; www.asminternational.org/shape.

7–11 Nanotech 2006/Bio Nano 2006, *Boston, MA*. Sarah Wenning, 696 San Ramon Valley Blvd., Ste. 423, Danville, 925-901-4959; fax 925-886-8461; e-mail wenning@nsti.org; www.nsti.org/Nanotech2006.

7–11 SPE—Annual Technical Conference (ANTEC), *Charlotte, NC*. Society of Plastics Engineers, SPE—Europe, Belgium; 32-0-3-541-77-55; fax 32-0-3-541-84-25; e-mail spe.europe@pi.be; www.speurope.org.

7–12 ▼ Electrochemical Society Meeting, *Denver, CO*. Electrochemical Society, 65 South Main Street, Building D, Pennington, NJ, 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org/meetings/future/209/meeting.htm.

7–12 Intl. Symp. on Dielectrics for Nanosystems: Materials Science, Processing, Reliability, and Manufacturing II, *Denver, CO*. Durgamadhhab Misra, New Jersey Institute of Tech., 161 Warren St., Newark, 973-596-5739; fax 973-596-5680; e-mail dmsira@njit.edu; www.electrochem.org/meetings/future/209/meeting.htm.

7–12 World Conf. on Photovoltaic Energy Conversion, *Waikoloa, HI*. Sheila Bailey, NASA Glenn Research Center, Cleveland, 216-433-2228; fax 216-433-6106; e-mail sheila.g.bailey@nasa.gov; www.meetingassistant.com/PVSC/worldconference.php.

8–10 Intl. Conf. on Advances in Fluid Mechanics, *Skithos, Greece*. Wessex Institute of Technology Conferences, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK; 44-0-238-029-3223; fax 44-0-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk/conferences/2006/afm06.

8–11 IEEE Intl. Conf. on Indium Phosphide and Related Materials (IPRM), *Princeton, NJ*. IEEE/LEOS, 445 Hoes Lane, PO Box 1331, Piscataway, NJ, 08855; 732-562-3899; fax 732-562-8434; e-mail leosconferences@ieee.org; www.i-leos.org.

10–12 ▼ World Conf. on Boundary Elements and Other Mesh Reduction Methods, *Skithos, Greece*. Wessex Institute of Technology Conferences, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK, 44-0-238-029-3223; fax 44-0-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk/conferences/2006/bem28.

10-12 ▼ World Congress on Biosensors (BIOSENSORS 2006), *Toronto, ON*. Janet Seabrook, Elsevier, The Boulevard, Langford Lane, Kidlington, Oxford, OX5 1GB, UK, +44 (0)1865 843691; fax +44 (0)1865 853282; e-mail jm.seabrook@elsevier.com; www.biosensors-congress.elsevier.com.

12-16 ▼ American Association of Immunologists (AAI) Annual Meeting, *Boston, MA*. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings.

13-16 Particles 2006—Medical/Biochemical Diagnostic, Pharmaceutical, and Drug Delivery Applications of Particle Technology, *Orlando, FL*. Particles 2006, 265 Clover Street, Rochester, NY 14610-2246; 585-288-5913; fax 585-482-7795; e-mail info@nanoparticles.org; nanoparticles.org/Particles2006.

14-17 Intl. Pharmaceutical Industry Conf., *Edinburgh, United Kingdom*. Laura Milne, SCI 14/15 Belgrave Square, London, United Kingdom, 44-0-20-7598-1565; fax 44-0-20-7235-7743; e-mail laura.milne@soci.org; www.soci.org/SCI/SClpharm/html/home.jsp.

14-19 Intl. Fatigue Congress (Fatigue 2006), *Atlanta, GA*. Nina Woods, Elsevier, The Boulevard, Langford Lane, Kidlington, Oxford, United Kingdom, 44-0-1865-843297; fax 44-0-1865-843958; e-mail n.woods@elsevier.com; www.fatigue2006.com.

15-17 Intl. Surface Engineering Congress, *Seattle, WA*. ASM International Customer Service, 9639 Kinsman Road, Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; customer.service@asminternational.org.

15-17 Intl. Thermal Spray Conf. and Exposition, *Seattle, WA*. International ASM, 9639 Kinsman Rd., Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; e-mail Cust-srv@asminternational.org; www.asminternational.org/itsc.

15-18 AeroMat Conf. & Exposition, *Seattle, WA*. ASM International Customer Service, 9639 Kinsman Road, Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; customer.service@asminternational.org.

15-18 ICNDST & ADC 2006 Joint Conf., *Research Triangle Park, NC*. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS**

15-19 ▼ Intl. Symp. on Blue Laser and Light Emitting Diodes (ISBLLLED), *Montpellier, France*. Thierry Bretagnon, University Montpellier II, GES-CC074, F-34095, Montpellier, Cedex, France, e-mail secretary@ges.univ-montp2.fr; www.isbllled2006.org.

15-20 Intl. Symp. on Functional Pi-Electron Systems, *Osaka, Japan*. Kenichi Nakayama, Osaka University, 2-1 Yamadaoka, Suita, Osaka, Japan, e-mail nakayama@mls.eng.osaka-u.ac.jp; www.molsys.mls.eng.osaka-u.ac.jp/tpi7.

16-17 Blowing Agents and Foaming Processes 2006, *Munich, Germany*. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, United Kingdom, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/blowingagents06.

16-19 Glass and Optical Materials Meeting, *Greenville, SC*. American Ceramic Society, Suite 100, Westerville, OH, 43081; 614-890-4700; fax 614-899-6109; e-mail info@ceramics.org; ceramics.org/meetings/gomd06.

16-20 ▼ APS—Annual Division of Atomic, Molecular and Optical Physics Meeting, *Knoxville, TN*. APS, jmaccek@utk.edu; www.aps.org/meet/calendar.cfm.

17-19 Intl. Symp. Interface Biology of Implants, *Rostock, Germany*. Joachim Rychly, Universität Rostock, Ernst-Heydemann-Str. 6, 18057 Rostock, Rostock, Germany, 49-0-381-494-7773; fax 49-0-381-494-5730; e-mail joachim.rychly@med.uni-rostock.de; www.uni-rostock.de/ibi.

20-24 ▼ Intl. Society of Analytical Cytology (ISAC) Meeting, *Quebec City, QC*. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings.

21-24 ▼ 2006 Biennial Polymer Innovation at Emerging Boundaries of Science and Engineering, *Key Biscayne, FL*. Lesia Linkous, Virginia Tech, 410 Davidson Hall, MC 0279, Blacksburg, VA, 24061; 540-231-3052; fax 540-231-2588; e-mail lesiar@vt.edu; www.polyacs.org/arcmeetings/biennial.506.shtml.

21-26 Conf. on Lasers and Electro-Optics - Quantum Electronics and Laser Science (CLEO/QELS), *Long Beach, CA*. Optical Society of America, 2010 Massachusetts Ave., NW, Washington, 202-223-8130; fax 202-223-1096; e-mail info@osa.org; www.cleoconference.org.

21-26 Polymer Reaction Engineering, *Halifax, NS*. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6ab.html.

22-25 Intl. Symp. on Colloidal and Molecular Electrooptics (ELOPTO-2006), *Kyoto, Japan*. Tsuneo Okubo, Yamagata University, Cooperative Research Center, Johnan 4-3-16 Yonezawa 992-8510 Japan; 81-238-26-3602; fax 81-238-26-3409; e-mail okubo@yz.yamagata-u.ac.jp; www.elopto.jp.

22-26 ICMOVPE XIII—Intl. Conf. on Metal-Organic Vapor Phase Epitaxy, *Miyazaki, Japan*. Yoshinao Kumagai, Tokyo University of A & T, Koganei, Tokyo 184-8588, Japan; 81-42-388-7469; fax 81-42-386-3003; e-mail icmovpe@cctuat.ac.jp; icmovpe13.chem.tuat.ac.jp

23-27 Seminar and Meeting on Ceramics, Cells and Tissues: Materials for Scaffolding of Biologically Engineered Systems, *Faenza, Italy*. Rossella Ravaglioli, ISTE-CNR, Via Granarolo, 64-48018, Faenza, Ravenna, Italy, 39-0546-670-311; fax 39-0546-670-399; e-mail 10cct@agenziapoloceramico.it; www.istec.cnr.it.

24-26 Intl. Conf. Comparing Design in Nature with Science and Engineering, *The New Forest, UK*. Wessex Institute of Technology Conferences, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK; 44-0-238-029-3223; fax 44-0-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk/conferences/2006/design06.

24-27 Intl. Conf. on Perspective Technologies and Methods in MEMS Design (MEMSTECH), *Lviv, Ukraine*. Mykola Pereyina, Lviv Polytechnic National University, St. Bandera 12, 79013, Lviv, Ukraine, 38-0322-72-29-72; fax 38-0322-72-29-72; e-mail memstech@polynet.lviv.ua; www.lp.edu.ua/Institute/IKN/CAD/MEMSTECH.

25-26 ▼ Baosteel Biennial Academic Conf. (BAC 2006), *Shanghai, China*. Secretariat Shanghai Baosteel Group Corporation, Room 401, Building 0, Baosteel Technology Center, No. 889 Fujin Road, Baoshan District, Shanghai 201900, P.R. China, 86-21-26649887; fax 86-21-56781258; e-mail BAC2006@baosteel.com; BAC.baosteel.com.

26 IEEE/LEOS Semiconductor Laser Workshop, *Long Beach, CA*. IEEE/LEOS, 445 Hoes Lane, PO Box 1331, Piscataway, NJ, 08855; 732-562-3899; fax 732-562-8434; e-mail leosconferences@ieee.org; www.i-leos.org.

28-1 Intl. Symp. on Macro- and Supramolecular Architectures and Materials (MAM-06): Practical Nano-Chemistry and Novel Approaches, *Tokyo, Japan*. Waseda University, Symposium MAM-06, Tokyo, Japan, 81-3-3200-2669; fax 81-3-3209-5522; e-mail MAM-06@mse.waseda.ac.jp; www.waseda.jp/assoc-MAM-06.

28-2 MCWASP—Modeling of Casting, Welding and Advanced Solidification Processes Conference, *Opio, France*. ESA Conference Bureau/Congrex Holland BV, MCWASP, P.O. Box 299, AG Noordwijk, Netherlands; 31-71-565-5005; fax 31-71-565-5658; e-mail Esa.Conference.Bureau@esa.int; www.mcwasp.org.

29-2 E-MRS—IUMRS—ICEM 06, *Nice, France*. P. Siffert, E-MRS 2006 Spring Meeting, BP 20, 67037 Strasbourg Cedex 2, France; 33-3-88-10-65-43; fax 33-3-88-10-63-43; e-mail emrs@phase.c-strasbourg.fr; www-emrs.c-strasbourg.fr/2006_SPRING/2006_meeting.htm. **IUMRS; E-MRS.**

29-2 Structure and Mechanical Properties of Nanostructured Materials, *Beijing, P.R. China*. ECI, 6 Metro Tech Center, Brooklyn, NY 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6au.html.

JUNE 2006

3-8 IEEE Intl. Conf. on Plasma Sciences (ICOPS), *Acme, MI*. Claire Rosser, Michigan State University, Rm. B100 RCE, East Lansing, MI, 48824; 517-432-8711; fax 517-432-8714; e-mail mcrosser@egr.msu.edu; www.icops2006.org.

4-9 Intl. Conf. on Modern Materials Science and Technology (CIMTEC), *Acireale, Italy*. Corso Mazzini, CIMTEC, 52—P.O. Box 174 48018, Faenza, Italy; 546-22461; fax 39-546-664138 e-mail congress@technagroup.it; www.cimtec-congress.org.

5-8 2nd Intl. FIB Congress 2006 (Intl. Federation for Structural Concrete), *Naples, Italy*. Secretariat FIB Congress, University of Naples Federico II, via Claudio, 21 - 80125, Naples, Italy, e-mail fib2006@unina.it; www.naples2006.com.

6-7 Medical Polymers 2006, *Cologne, Germany*. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, UK, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/medicalpolymers06.

6-8 Magneto-Optical Recording Intl. Symp. 2006 (MORIS 2006) Workshop, *Chiba Prefecture, Japan*. MORIS 2006 Workshop Secretariat, Proactive Inc., Promena Kobe 16F, 1-8-1, Higashikawasaki-cho, Chuo-ku, Kobe 650-0044, Japan; 81-78-366-5050; fax 81-78-366-5051; moris2006ws@pac.ne.jp; www.ecs.cst.nihon-u.ac.jp/moris2006ws. **Endorsed.**

7-9 ▼ Intl. Conf. on Monitoring, Simulation, Prevention and Remediation of Dense and Debris Flows, *Rhodes, Greece*. Wessex Institute of Technology Conferences, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK, 44-0-238-029-3223; fax 44-0-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk/conferences/2006/debris06.

8-10 IEEE Intl. Symp. on Technology and Society (ISTAS), *Queens, NY*. Clinton Andrews, Rutgers University, 33 Livingston Ave. #302, New Brunswick, NJ, 08901; 732-932-3822 ext721; fax 732-932-2253; e-mail c.j.andrews@ieee.org; www.ieeesit.org.

11-15 Advanced Membrane Technology III: Membrane Engineering for Process Intensification, *Cetraro, Italy*. ECI, 6 Metro Tech Center, Brooklyn, NY 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6aj.html.

11-15 Intl. Conf. on Transport Phenomena in Micro and Nanodevices, *Barga, Italy*. ECI, 6 Metro Tech Center, Brooklyn, NY 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6at.html.

11-16 ▼ Gordon Research Conf. on Ligand Recognition and Molecular Gating, *Barga, Italy*. Benjamin Kaupp, Research Centre Juelich, IBI-1, Juelich 52428, Germany, e-mail a.eckert@fz-juelich.de; www.grc.org/programs/2006/ligand.htm.

11-16 ▼ Gordon Research Conf. on Multiphoton Processes, *Tilton, NH*. Robert Jones, University of Virginia, 382 McCormick Road, PO Box 400714, Charlottesville, VA, 22904-4714; e-mail rrj3c@virginia.edu; www.grc.org/programs/2006/multipho.htm.

12-14 Intl. Conf. Advances in Fusion and Processing of Glass, *Dresden, Germany*. German Society of Glass Technology (DGG), Siemensstrabe 45, 63071 Offenbach, Germany; 49-0-69-975861-0; fax 49-0-69-975861-99; e-mail dgg@hvg-dgg.de; www.hvg-dgg.de/de/8th_international_conference.htm.

12-14 ▼ Printing of Functional Materials: Fundamental Chemistry and Materials Science, *Manchester, UK*. RSC Conferences, Thomas Graham House, Science Park, Milton Road, Cambridge CB4 0WF, UK, 44-0-1223-432254; fax 44-0-1223-423623; www.rsc.org/ConferencesAndEvents/RSCConferences/PFM.

12-15 Microwave Materials and their Applications, *Oulu, Finland*. MMA 2006, Microelectronics and Materials Physics Laboratories, Dept. of Electrical Engineering, University of Oulu, Linnanmaa, FIN-90570 Oulu, Finland; mma2006@ee.oulu.fi; www.ee.oulu.fi/research/miklab/mma2006.

12-16 ▼ Great Lakes Photonics Symp. 2006, *Dayton, OH*. SPIE Meetings, P.O. Box 10, Bellingham, WA, 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; spie.org/Conferences/calls/06/gl.

13-16 Northern Optics (NO2006), *Bergen, Norway*. Gerd Pettersen, Instituttvegen 25, PO Box 70, NO-2027 Kjeller, Norway, 47-6484-4703; fax 47-6381-8146; e-mail gerd@unik.no; web.unik.no/NO2006.

17-21 ▼ MPIF Intl. Conf. on Powder Metallurgy and Particulate Materials (PowderMet 2006), *San Diego, CA*. MPIF, 105 College Road East, Princeton, NJ, 08540; 609-452-7700; fax 609-987-8523; e-mail info@mpif.org; www.mpiif.org/Meetings.

18-21 ACS Colloid and Surface Science Symp., *Boulder, CO*. Daniel Schwartz, University of Colorado, Dept. of Chemical Engineering, Boulder, CO 80309-0424; 303-735-0240; fax 303-492-4341; e-mail daniel.schwartz@colorado.edu; www.colloid.org.

18-22 ▼ **Electroceraamics X**, *Toledo, Spain*. Instituto de Cerámica y Vidrio, Sociedad Española de Cerámica y Vidrio, Kelsen 5, 28049 Cantoblanco, Madrid, Spain, 34-91-735-58-40; fax 34-91-735-58-43; e-mail electroceramics-x@icv.csic.es; www.estyloweb.com/electroceraamics-x. **Endorsed.**

18-23 ▼ Gordon Research Conf. on Basement Membranes, *Barga, Italy*. Reinhard Faessler, Max Planck Institute for Biochemistry, Dept. Molecular Medicine, Am Klopferstutz 18A, Martinsried D-82152, Germany, e-mail faessler@biochem.mpg.de; www.grc.org/programs/2006/basement.htm.

18-23 ▼ Gordon Research Conf. on Tribology, *Waterville, ME*. Tom Dickinson, Washington State University, Department of Physics, Pullman, WA, 99164-2814; e-mail jtd@wsu.edu; www.grc.org/programs/2006/tribo.htm.

19-23 ▼ Cell-Materials Interactions: Regenerative Medicine, *Porto, Portugal*. Secretariat Cell-Material Interactions, Universidade do Porto, Biomaterials Laboratory, Rua do Campo Alegre, 823, 4150-180, Porto, Portugal, 35-1-22-6074982; fax 35-1-22-6094567; e-mail info@ineb.up.pt; http://www.ineb.up.pt.

21-25 ASME 2006 Summer Bioengineering Conf., *Amelia Island, FL*. Barry Lieber, University of Miami, Biomedical Engineering, Rm 203 McArthur Annex, 1251 Memorial Drive, Coral Gables, FL 33146; e-mail blieber@miami.edu; divisions.asme.org/bed/events/summer06.html.

24-30 **Beijing Intl. Materials Week**, *Beijing, China*. Lin Jianyun, Room 4102, 62 Zizhuyuan Road, Beijing, China, 86-10-68722031; fax 86-10-68722033; e-mail 2006BIMW@sohu.net; www.c-mrs.org.cn/ehuiyi_list.asp. **C-MRS.**

25-29 Intl. Congress on Ceramics, *Toronto, Canada*. American Chemical Society, 1155 Sixteenth Street NW, Washington, DC, 20036; 202-872-4374; fax 202-872-6128; e-mail natlmtgs@acs.org; www.ceramics.org.

25-30 ▼ Gordon Research Conf. on MEMS Technology and Biomedical Applications, *New London, CT*. Rafael Kleiman, McMaster University, Engineering Physics Dept., 1280 Main Street West, Hamilton, ON L8S 4L7, Canada; e-mail kleiman@mcmaster.ca; www.grc.org/programs/2006/mems.htm.

25-30 ▼ Gordon Research Conf. on Permeable Sediments, *Waterville, ME*. Carolyn Oldham, University of Western Australia, Center for Water Research, 35 Stirling Highway, Crawley, WA 6009, Australia, e-mail c.oldham@cw.r.uwa.edu.au; www.grc.org/programs/2006/permsed.htm.

25-30 ▼ Gordon Research Conf. on Three Dimensional Electron Microscopy, *Barga, Italy*. Helen Saibil, Birkbeck College, Crystallography Dept., Malet Street, London WC1E 7HX, UK; e-mail h.saibil@mail.cryst.bbk.ac.uk; www.grc.org/programs/2006/threed.htm.

25-30 Novel and Emerging Ceramics and Composites, *Kona Coast, HI*. ECI 6 Metro Tech Center, Brooklyn, NY 11201; 718-260-3743, fax 718-260-3754; e-mail info@eci.com; www.engconfintl.org/6afbody.html.

26-28 IASTED Intl. Conf. on Applied Simulation and Modelling, *Rhodes, Greece*. Secretariat IASTED, #80, 4500 16th Ave. N.W., Calgary, AB, T3B 0M6; 403-288-1195; fax 403-247-6851; e-mail calgary@iasted.org; www.iasted.org/conferences/2006/Greece/c522.htm.

26-29 ECM VII: Cartilage & Joint Repair, *Davos, Switzerland*. Sonia Wahl, AO Research Institute, Clavadelerstrasse, CH-7270 Davos Platz, Davos, Switzerland, 41-81-41-42-541; fax 41-81-41-42-299; e-mail sonia.wahl@aofoundation.org; www.ecmjournal.org/ecm_meetings/ecm7.

26-29 Intl. Energy Conversion Engineering Conf. (IECEC 2006), *San Diego, CA*. Michael Piszczor, NASA Glenn Research Center, Cleveland, OH, 44135; 216-433-2237; e-mail michael.piszczor@grc.nasa.gov; www.aiaa.org/events/iecec.

26-30 IEEE Intl. Conf. on Properties and Applications of Dielectric Materials (ICPADM), *Bali, Indonesia*. Dr. Suwarno, Bandung Institute of Technology, Jl. Ganesha 10, Bandung, Indonesia, 62-22-250-2260; fax 62-22-253-4222; e-mail suwarno@iee.org; www.icpdm2006.com.

26-30 ▼ National Space and Missile Materials Symp., *Orlando, FL*. Dan Cleyrat, National Space & Missile Materials Symposium, C/O: Anteon Corporation, 5100 Springfield Pike, Suite 509, Dayton, OH 45431, 937-656-6482; fax 937-254-2153; e-mail daniel.cleyrat@wpafb.af.mil; www.usasymposium.com/nsms.

28-29 ▼ TMS Electronic Materials Conf. (EMC), *University Park, PA*. TMS Meetings Services, 184 Thorn Hill Road, Warrendale, PA, 15086; 724-776-9000 x243; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/EMC.html.

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2-6 European Conf. on Foams, Emulsions and Applications (EUFOAM 2006), *Potsdam, Germany*. Reinhard Miller, Max Planck Institut Colloids and Interfaces, Am Muelenberg 1, D-14476 Potsdam-Golm, Germany; 49-331-567-9252; fax 49-331-567-9202; e-mail eufoam2006@mpikg.mpg.de; www.mpihg.mpg.de/en/gf/foam2006.

2-6 ▼ Gordon Research Conf. on Defects In Semiconductors, *New London, NH*. Wladek Walukiewicz, Lawrence Berkeley National Laboratory, 1 Cyclotron Road, MS 2-200, Berkeley, CA, 94720; e-mail w_walukiewicz@lbl.gov; www.grc.org/programs/2006/defects.htm.

2-7 21st International Liquid Crystal Conference, *Keystone, CO*. Kinsley & Associates, Conference Management Office, LLC, 303-798-3664; ilcc@kinsleyassociates.com; www.ilcc2006.com.

2-7 ▼ Gordon Research Conf. on Vibrational Spectroscopy, *Biddeford, ME*. F. Fleming Crim, University of Wisconsin, Department of Chemistry, 1101 University Ave., Madison, WI, 53706; e-mail fcgrim@chem.wisc.edu; www.grc.org/programs/2006/vibrat.htm.

3-7 ▼ European Conf. of Fracture, *Alexandroupolis, Greece*. Emmanuel Gdoutos, Democritus University of Thrace, School of Engineering, GR-671 00, Xanthi, Greece, 30-25410-79651; fax 30-25410-79652; e-mail egdoutos@civil.duth.gr; ecf16.civil.duth.gr.

4-8 ▼ Intl. Conf. on Processing and Manufacturing of Advanced Materials, *Vancouver, Canada*. Tatiana Joksimovic, Services Suite 645, 375 Water Street, Vancouver, BC, V6B 5C6, Canada; 604-681-2503; fax 604-681-5226; e-mail thermec2006@venuewest.com; thermec.uow.edu.au.

5-7 ▼ Intl. Conf. on Advanced Computational Methods and Experimental Measurements in Heat and Mass Transfer, *The New Forest, UK*. Wessex Institute of Technology Conferences, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK, 44-0-238-029-3223; fax 44-0-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk/conferences/2006/heat06.

5-7 ▼ Intl. Symp. on Organocatalysis in Organic Synthesis, *Glasgow, UK*. RSC Conferences, Thomas Graham House, Science Park, Milton Road, Cambridge CB4 0WF, UK, 44-0-1223-432254; fax 44-0-1223-423623; www.rsc.org/ConferencesAndEvents/RSCConferences/organocat06.

9-12 Fractography of Glasses and Ceramics V, *Rochester, NY*. The American Ceramic Society, 735 Ceramic Place, Suite 100, Westerville, OH 43081; 614-890-4700; fax 614-899-6109; e-mail info@ceramics.org; engineering.alfred.edu/outreach/conf/fractography.

9-12 Intl. Symp. on New Materials for Electrochemical Systems, *Montréal, Canada*. Secretariat New Materials 2006, Bureau des Congrès Universitaires, 6600 Côte-des-Neiges Road, Suite 510, Montreal, Quebec, H3S 2A9 Canada; 514-340-3215; fax 514-340-4440; e-mail newmat@congresbcu.com; newmaterials.congresbcu.com.

9-13 Structure and Dynamics of Self-Organized Macromolecular Systems, *Prague, Czech Republic*. Petr Štěpánek, Institute of Macromolecular Chemistry, Heyrovského nám. 2, CZ-162 06 Praha 6, Praha, Czech Republic, 420-296-809-332; fax 420-296-809-410; e-mail sympo@imc.cas.cz; www.imc.cas.cz/sympo/45micro.html.

10-12 ▼ Faraday Discussion 134: Atomic Transport and Defect Phenomena in Solids, *Guildford, UK*. RSC Conferences, Thomas Graham House, Science Park, Milton Road, Cambridge CB4 0WF, UK, 44-0-1223-432254; fax 44-0-1223-423623; www.rsc.org/ConferencesAndEvents/RSCConferences/FD134.

10-12 ▼ Intl. Association for Boundary Element Methods (IABEM) Conf., *Graz, Austria*. Martin Schanz, Graz University of Technology, Institute of Applied Mechanics, Technikerstr. 4, A-8010, Graz, Austria, 43-316-873-7640; fax 43-316-873-7641; e-mail iabem2006@tugraz.at; www.iabem2006.tugraz.at.

10-12 ▼ Intl. Meeting on High Performance Computing for Computational Science (VECPAR2006), *Rio de Janeiro, Brazil*. Suely Lima, IMPA/Scientific Activities Department (DAC), Estrada Dona Castorina, 110, Jardim Botânico, Rio de Janeiro, RJ, Brazil, 22460-320, 55-21-25295277; fax 55-21-25295019; e-mail dac@impa.br; vecpar.fe.up.pt/2006.

16-20 IEEE Conf. on Nanotechnology (IEEE-NANO), *Cincinnati, OH*. Clifford Lau, Institute for Defense Analyses, 4850 Mark Center Drive, Alexandria, VA, 22311; 703-933-6525; fax 703-845-6848; e-mail clau@ida.org; www.ececs.uc.edu/~mcahay/Nano2006/index2006.html.

16-20 ▼ NC-AFM2006 9th Intl. Conf. on Noncontact Atomic Force Microscopy, *Kobe, Japan*. Masayuki Abe, Osaka University, Japan, e-mail ncafm.ele.eng.osaka-u.ac.jp; ncafm.ele.eng.osaka-u.ac.jp.

16-21 ▼ Gordon Research Conf. on Inorganic Chemistry, *Newport, RI*. Bahram Moasser, GE Global Research Center, Bldg CE, Room 134, One Research Circle, Niskayuna, NY, 12309; e-mail moasser@crd.ge.com; www.grc.org/programs/2006/inorchem.htm.

16-21 ▼ Gordon Research Conf. on Plasma Processing Science, *South Hadley, MA*. Alexander Fridman, Drexel University, MEM Dept., 3141 Chestnut Street, Philadelphia, PA, 19104; e-mail fridman@drexel.edu; www.grc.org/programs/2006/plasma.htm.

16-22 World Congress on Computational Mechanics, *Los Angeles, CA*. WCCM 2006, e-mail wccm2006@seas.ucla.edu; www.wccm2006.northwestern.edu.

22-26 Annual Meeting and Exposition of the Controlled Release Society, *Vienna, Austria*. Controlled Release Society, 3650 Annapolis Lane North, Suite 107, Minneapolis, MN 55447-5434; 763-512-0909; fax 763-765-2329, e-mail meetings@controlledrelease.org; www.controlledrelease.org.

23-28 ▼ Gordon Research Conf. on Granular and Granular-Fluid Flow, *Oxford, UK*. Christine Hrenya, University of Colorado, Dept. of Chemical and Biological Engineering, UCB 424, Boulder, CO, 80309; e-mail hrenya@colorado.edu; www.grc.org/programs/2006/granular.htm.

23-28 ▼ Gordon Research Conf. on Physical Metallurgy, *Plymouth, NH*. Alex King, Purdue University, School of Materials Engineering, 501 Northwestern Avenue, West Lafayette, IN, 47907-2044; e-mail alexking@ecn.purdue.edu; www.grc.org/programs/2006/physmet.htm.

23-28 ▼ Intl. Conf. on the Physics and Chemistry of Ice, *Bremerhaven, Germany*. PCI 2006, e-mail info@pccie2006.de; www.pccie2006.de.

30-2 Fifth Intl. Conf. on Synchrotron Radiation in Materials Science, *Chicago, IL*. www.aps.anl.gov/News/Conferences/2006/SRMS/.

30-2 IEEE Intl. Symp. on Applications of Ferroelectrics, *Sunset Beach, NC*. Jon-Paul Maria, 1001 Capability Drive, Research Building One, Office 322, Raleigh, NC 27606; 919-513-2843; fax 919-515-3419; e-mail jpmaria@ncsu.edu; www.ieee-uffc.org.

30-3 ▼ Advances in Materials and Processing Technologies (AMPT), *Las Vegas, NV*. Patricia Davidson, Ohio University, Community and Professional Programs, 113 Hanning Hall, Athens, OH 45701, 740-593-1767; fax 740-593-9476; e-mail davidson@ohio.edu; www.ohiou.edu/ampt.

30-3 ▼ Microscopy and Microanalysis 2006, *Chicago, IL*. Microscopy/Marketing & Education, Inc., Microscopy & Microanalysis Meeting Management, 125 Parido Street, Suite 102, Springfield, MA, 01118-2130; 972-954-8011; fax 972-954-8018; e-mail corporate@mme1.com; mm2006.microscopy.org.

30-4 ▼ Gordon Research Conf. on Biomineralization, *New London, NH*. Joanna Aizenberg, Lucent Technologies, Bell Laboratories, 700 Mountain Avenue, Room 1C-365, Murray Hill, NJ 07974-2008, e-mail jaizenberg@lucent.com; www.grc.org/programs/2006/biomin.htm.

30-4 ▼ Gordon Research Conf. on Flow and Transport in Permeable Media, *Andover, NH*. Martin Blunt, Imperial College, Dept. of Earth Science and Engineering, London SW7 2AZ, UK, e-mail m.blunt@imperial.ac.uk; www.grc.org/programs/2006/flow.htm.

30-4 ▼ Gordon Research Conf. on Thin Film and Small Scale Mechanical Behavior, *Waterville, ME*. Zhigang Suo, Harvard University, Engineering and Applied Sciences Div., 29 Oxford Street, Pierce Hall 309, Cambridge, MA, 02138; e-mail suo@deas.harvard.edu; www.grc.org/programs/2006/thinfilm.htm.

30-4 ▼ ICN&T2006 Intl. Conf. on Nanoscience and Technology, *Basel, Switzerland*. ICN&T 2006, c/o AKM Congress Service, Clarastrasse 57, CH-4005 Basel, Switzerland, 41-61-686-77-11; fax 41-61-686-77-88; e-mail info@akm.ch; www.icnt2006.ch.

31-4 Intl. Conf. on Ultrafast Phenomena, *Pacific Grove, CA*. Optical Society of America, 2010 Massachusetts Ave., NW, Washington, 202-223-8130; fax 202-223-1096; e-mail info@osa.org; www.osa.org/meetings/topicals/up.

AUGUST 2006

5-9 ▼ Symp. of The Protein Society, *San Diego, CA*. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings.

6-10 IMS Annual Convention, *Chicago, IL*. ASM International Customer Service, 9639 Kinsman Road, Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; customer.service@asminternational.org; www.asminternational.com.

6-11 ▼ Gordon Research Conf. on Macromolecular Organization and Cell Function, *South Hadley, MA*. Ronald Lynch, University of Arizona, Arizona Health Sciences Center, Dept. of Physiology, Tucson, AZ, 85724; e-mail rlynch@u.arizona.edu; www.grc.org/programs/2006/macromol.htm.

6-11 ▼ Gordon Research Conf. on Science of Adhesion, *Tilton, NH*. William Unertl, University of Maine, Physics and Astronomy Dept., Bennett Hall, Orono, ME 04469, e-mail unertl@maine.edu; www.grc.org/programs/2006/adhesion.htm.

13-17 SPIE—Optics and Photonics, *San Diego, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; spie.org/app/conferences.

13-18 ▼ Gordon Research Conf. on Electron Donor Acceptor Interactions, *Newport, RI*. Clifford Kubiak, University of California, San Diego, Dept. of Chemistry and Biochemistry, 9500 Gilman Dr., La Jolla, CA 92093-0358; e-mail ckubiak@ucsd.edu; www.grc.org/programs/2006/eleccon.htm.

13-18 ▼ Gordon Research Conf. on Science and Technology Policy, *Big Sky, MT*. Frederick Grinnell, UT Southwestern Medical Center, Dept. of Cell Biology 5323 Harry Hines Blvd., Dallas, TX, 75230; e-mail frederick.grinnell@utsouthwestern.edu; www.grc.org/programs/2006/policy.htm.

14-18 IEEE Intl. Symp. on Electromagnetic Compatibility (EMC 2006), *Portland, OR*. Vita Feuerstein, IEEE, 445 Hoes Lane, Piscataway, 732-562-6826; fax 732-981-1203; e-mail vita@ieee.org; www.emc2006.org.

19-23 ACS National Meeting & Exposition, *Boston, MA*. National Expositions American Chemical Society, 1155 Sixteenth Street, Washington, DC, 20036; e-mail expo@acs.org; www.chemistry.org/expositions.

19-25 World Renewable Energy Congress and Exhibition, *Florence, Italy*. Ali Sayigh, PO Box 362, Brighton BN2 1YH, United Kingdom, 44-1273-625-643; fax 44-1273-625-768; e-mail asayigh@netcomuk.co.uk; www.wreenuk.co.uk/wreenuk.html.

20-25 ▼ Gordon Research Conf. on Drug Carriers in Medicine and Biology, *Big Sky, MT*. Alexander Kabanov, Univ. of Nebraska Medical Center, 985830 Nebraska Medical Center, Omaha, NE 68198-5830; e-mail akabanov@unmc.edu; www.grc.org/programs/2006/drugcarr.htm.

20-25 Intl. Conf. on the Application of Accelerators in Research and Industry, *Fort Worth, TX*. Margaret Hall, University of North Texas, PO Box 311427, Denton, TX, 76203-1427; 940-565-3250; fax 940-565-2227; e-mail caari2006@unt.edu; www.caari2006.com.

20-26 Intl. Conf. on Nanostructured Materials, *Bangalore, India*. Prof. K. Chattopadhyay, Dept. of Metallurgy, Indian Institute of Science, Bangalore 560 012, India; 91-80-22932262; fax 91-80-23601991; e-mail nano2006@met.iisc.ernet.in; met.iisc.ernet.in/~nano2006.

21-24 IEEE/LEOS Intl. Conf. on Optical MEMs and Their Applications (MOEMS), *Big Sky, MT*. IEEE/LEOS, 445 Hoes Lane, PO Box 1331, Piscataway, NJ, 08855; 732-562-3899; fax 732-562-8434; e-mail leosconferences@ieee.org; www.i-leos.org.

21-25 ▼ Intl. Conf. on Biomagnetism, *Vancouver, Canada*. Secretariat Biomag 2006, c/o Venue West Conference Services Ltd., 645 - 375 Water Street, Vancouver, BC, Canada V6B 5C6; 604-681-5226; fax 604-681-2503; e-mail congress@venuewest.com; www.biomag2006.ca.

23-25 ▼ NESAC/BIO Workshop on Surface Characterization of Biomaterials, *Seattle, WA*. University of Washington, NESAC/BIO—National ESCA and Surface Analysis Center, Depts. of Bioengineering and Chemical Engineering Box 351750, Seattle, WA 98195-1750, 206-685-1229; fax 206-543-3778; e-mail info@nb.engr.washington.edu; www.nb.engr.washington.edu.

26-27 GIA Gemological Research Conf., *San Diego, CA*. GIA, 5345 Armada Drive, Carlsbad, CA 92008-4602; 760-603-4019; fax 760-603-4021; e-mail gemconference@gia.edu; www.gia.edu/newsroom/608/21821/news_release_details.cfm.

27-31 TMS—Sohn Intl. Symp. on Advanced Materials: Principles, Technologies, and Industrial Practice, *San Diego, CA*. TMS Meetings Services, 184 Thorn Hill Road, Warrendale, PA, 15086; 724-776-9000 x243; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/Meetings/Specialty/FallExt2006/FallExt2006-Home.html. **Endorsed.**

27-1 World Congress on Medical Physics and Biomedical Engineering (WC 2006), *Seoul, South Korea*. Secretariat WC 2006, SL Gangnam, PO Box 305, Seoul, Korea (South), 82-2-3476-7700; fax 82-2-3476-8800; e-mail wc2006@koconex.com; www.wc2006-seoul.org.

29-1 ▼ Conf. on Computational Physics (CCP 2006), *Gyeongju, South Korea*. CCP 2006, e-mail asw@physics.postech.ac.kr; ccp2006.postech.edu.

30-3 Intl. Conf. of the IEEE Engineering in Medicine and Biology Society, *New York, NY*. Jodi Strock, IEEE/EMBS, 445 Hoes Lane, Piscataway, 732-562-3451; fax 732-981-1769; e-mail j.strock@ieee.org; www.ieee.org.

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3-7 Polymer Networks Group Conf. 2006—Functional and Biological gels and networks: theory and experiment, *Sheffield, UK*. Shelagh Cowley, University of Sheffield, Dainton Building, Brook Hill, Sheffield, UK; 44-0-114-222-9537; fax 44-0-114-222-9389; e-mail s.h.cowley@sheffield.ac.uk; www.polymernetworks.group.shef.ac.uk.

3-8 ▼ Gordon Research Conf. on Bioelectrochemistry, *Aussois, France*. Justin Teissie, CNRS, Inst. of Pharma and Struct Biology, 205 Route de Narbonne, UMR 5089, Toulouse, Cedex 31077, France; e-mail justing.teissie@ipbs.fr; www.grc.org/programs/2006/bioelec.htm.

4-8 ▼ Trends in Nanotechnology (TNT2006), *Grenoble, France*. Antonio Correia, Fundacion PHANTOMS, Madrid Science Park, Pabellón C, Ctra. Colmenar Viejo Km 15, Ciudad Universitaria de Cantoblanco-UAM, 28049 Madrid, Spain; e-mail antonio@phantomsnet.net; www.tnt2006.org.

5-8 European Conf. on Computational Fluid Dynamics (ECCOMAS CFD 2006), *Egmond aan Zee, Netherlands*. Secretariat ECCOMAS CFD 2006, Delft University of Technology, Mekelweg 4, 2628 CD Delft, Delft, Netherlands, 31-0-6-27227520; fax 31-0-10-5112119; e-mail eccomas CFD2006@math.tudelft.nl; www.eccomas CFD2006.nl.

6-8 Intl. Conf. on the Characterization and Control of Interfaces (ICCCI 2006), *Kurashiki, Japan*. Makio Naito, Osaka University, 11-1, Mihogaoka, Ibaraki, Osaka, Japan, 81-6-6879-8660; fax 81-6-6879-8680; e-mail m-naito@jwri.osaka-u.ac.jp; www.jwri.osaka-u.ac.jp/%7Econf/iccci2006/index.html.

10-14 ACS National Meeting and Exposition, *San Francisco, CA*. American Chemical Society, attn: National Expositions, 1155 Sixteenth Street, Washington, DC 20036; expo@acs.org; chemistry.org/expositions.

10-14 ▼ **IUMRS Intl. Conf. in Asia (IUMRS-ICA-2006)**, Jeju, Korea. Hyeongtag Jeon, Hanyang University, Division of Materials Science and Engineering, Seongdong-gu, Seoul 133-791, Korea; 82-2-2220-0387; fax 82-2-2292-3523; e-mail ica2006@hanyang.ac.kr; www.cheric.org/~ica2006. **MRS-K, IUMRS, C-MRS, MRS-I, MRS-J, MRS-S, MRS-T.**

10-15 ESOMAT—European Symp. on Martensitic Transformations, Bochum, Germany. ESOMAT; e-mail esomat06@ruhr-uni-bochum.de; www.ruhr-uni-bochum.de/esomat06.

10-15 ▼ Gordon Research Conf. on Electronic Spectroscopy and Dynamics, Les Diablerets, Switzerland. Frederic Merkt, ETH Zuerich, Lab. Fur Physikalische Chemie, ETH Honggerberg, HCI, Zuerich CH-8093, Switzerland; e-mail merkt@xuv.phys.chem.ethz.ch; www.grc.org/programs/2006/elecspec.htm.

12-15 Intl. Conf. on Computational Structures Technology (CST 2006), Las Palmas de Gran Canaria, Spain. Dun Eaglais, Civil-Comp Limited, Station Brae, Kippen, Stirling, United Kingdom, 44-0-1786-870-166; fax 44-0-1786-870-167; e-mail info@civil-comp.com; www.civil-comp.com/conf/cst2006.htm.

12-15 Intl. Conf. on Engineering Computational Technology (ECT 2006), Las Palmas de Gran Canaria, Spain. Dun Eaglais, Civil-Comp Limited, Station Brae, Kippen, Stirling, UK; 44-0-1786-870-166; fax 44-0-1786-870-167; e-mail info@civil-comp.com; www.civil-comp.com/conf/ect2006.htm.

13-14 ▼ Intl. Conf. on Foam Processing and Technology (FOAMS 2006), Itasca, IL. Society of Plastics Engineers, 14 Fairfield Drive, P.O. Box 403, Brookfield, CT 06804-0403; 203-775-0471, fax 203-775-8490; e-mail info@4spe.org; www.4spe.org/conf/foams06/0609foams.php.

13-15 European Conf. on Residual Stresses (ECSR 7), Berlin, Germany. Walter Reimers, Technical University Berlin, Sekr BH-18, Ernst-Reuter-Platz 1, Berlin, Germany, 49-0-30-314-22417; fax 49-0-30-314-22996; e-mail Walter.Reimers@TU-Berlin.de; www.tu-berlin.de/fak3/wewi/metallische_werkstoffe/ecrs7.

13-15 ▼ Intl. Conf. on Engineering Failure Analysis, Toronto, Canada. Claire Norris, ICEFA-II Conference Secretariat 51 Kestrel Way, Wokingham, Berkshire RG41 3HA, UK; 44-0-118-377-4696; fax 44-0-118-977-6680; e-mail icefa@elsevier.com; www.icefa.elsevier.com.

16-20 ▼ Thermoforming Conf., Nashville, TN. Society of Plastics Engineers, 14 Fairfield Drive, P.O. Box 403, Brookfield, CT 06804-0403; 203-775-0471, fax 203-775-8490; e-mail info@4spe.org; www.4spe.org/conf/thermo06/0609thermo.php.

17-19 ▼ Color and Appearance Conf., Cincinnati, OH. Society of Plastics Engineers, 14 Fairfield Drive, P.O. Box 403, Brookfield, CT 06804-0403; 203-775-0471, fax 203-775-8490; e-mail info@4spe.org; www.4spe.org/conf.

17-22 ▼ Intl. Conf. on Fatigue Damage of Structural Materials, Hyannis, MA. Sophie Peters, Elsevier, The Boulevard, Langford Lane, Kidlington, Oxford, UK; 44-0-1865-843643; fax 44-0-1865-843958; e-mail s.peters@elsevier.com; www.fatiguedamage.elsevier.com.

17-22 Workshop on Non Equilibrium Phenomena in Supercooled Fluids, Glasses and Amorphous Materials, Pisa, Italy. Laura Andreozzi, Università di Pisa, Largo Pontecorvo n.3, I-56127, Pisa, Italy, 39-050-2214891; fax 39-050-2214890; e-mail workshop4@df.unipi.it; wneqp4.df.unipi.it.

18-20 ▼ Materials Science & Technology Conf., Cincinnati, OH. Customer Service ASM International, 9639 Kinsman Road, Materials Park, OH, 44073-0002; 800-336-5152 ext 6; fax 440-338-4634; e-mail Customerservice@asminternational.org; www.asmiinternational.org.

18-21 ▼ Environmental Forensics: Chemical, Physical and Biological Methods, Durham, UK. RSC Conferences, Thomas Graham House, Science Park, Milton Road, Cambridge CB4 0WF, UK; 44-0-1223-432254; fax 44-0-1223-423623; www.rsc.org/ConferencesAndEvents/RSCConferences/EnvForen.

18-22 Intl. Conf. on the Structure of Non-Crystalline Materials, Praha, Czech Republic. Romana Kocova, Icaris Conference Management, m. Dr. Holého 8, 180 00 Praha 8—Liben, Czech Republic; 420-284-823-250; fax 420-266-312-113; e-mail romana@icaris.cz; www.icaris.info/NCM10.

19-20 Silicone Elastomers 2006, Frankfurt, Germany. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, United Kingdom, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/siliconeelastomers06.

20-22 ▼ Small Times NanoCon Intl., Las Vegas, NV. Kelli Felker, Small Times Media, 655 Phoenix Drive, Ann Arbor, MI, 48108; 734-528-6263; fax 734-994-1554; e-mail kelifelker@smalltimes.com; nce06.events.pennnet.com.

24-28 Intl. Symp. on Crystallization in Glasses and Liquids, Jackson Hole, WY. The American Ceramic Society, 735 Ceramic Place, Suite 100, Westerville, OH, 43081; 614-890-4700; fax 614-899-6109; e-mail info@ceramics.org; www.ceramics.org/meetings/crystallization.

24-29 Intl. Congress on Solid State Chemistry (SSC 2006), Pardubice, Czech Republic. Tomas Wagner, University of Pardubice, Legions Sq. 565, 532 10, Pardubice, Czech Republic, 420-466-037-144; fax 420-466-037-311; e-mail ssc@upce.cz; ssc.upce.cz.

24-29 Process Intensification and Process Innovation—(PI)2 II Cleaner, Sustainable, Efficient Technologies for the Future, Christchurch, New Zealand. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/gap.html.

27-28 ▼ nanoTX 06, Dallas, TX. nanoTX 06, 437 Southfork, Suite 400, Dallas/Fort Worth, TX, 75057; 214-513-9567; fax 866-815-0565; e-mail info@nanotx.biz; www.nanotx.biz.

OCTOBER 2006

1-5 Metabolic Engineering VI: From recDNA towards Engineering Biological Systems, Noordwijkerhout, Netherlands. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6ay.html.

3-6 World Congress on Emulsions, Lyon, France. 140 cours Charlemagne, 69002 Lyon, France; 33-0-4-72-77-45-50; fax 33-0-4-72-77-45-77; e-mail cme@package.fr; www.cme-emulsion.com.

4-6 Knowledge Foundation TCA Summit 2006—Innovations in Materials Science for Technology Commercialization, Washington, DC. Knowledge Foundation, 18 Webster Street, Brookline, MA, 02446-4938; (617) 232-7400; fax (617) 232-9171; e-mail custserv@knowledgefoundation.com; www.knowledgefoundation.com.

5-7 ACS Northeast Regional Meeting, Binghamton, NY. Beverly Johnson, American Chemical Society, Regional Meetings, 1155 Sixteenth Street, Washington, DC 20036; 202-872-6264; e-mail b_johnson@acs.org. **Endorsed.**

10-14 ▼ American Society of Human Genetics Annual Meeting, New Orleans, LA. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings.

10-14 Biomedical Engineering Society 2006 Annual Fall Meeting, Chicago, IL. Biomedical Engineering Society, 8401 Corporate Drive, Suite 225, Landover, MD, 20785-2224; 301-459-1999; fax 301-459-2444; e-mail info@bmes.org; www.bmes.org/meetings.asp.

16-19 Material Science and Technology Conf. and Exhibition (MS&T06), Cincinnati, OH. The American Ceramic Society, 735 Ceramic Place, Suite 100, Westerville, OH, 43081; 614-890-4700; fax 614-899-6109; e-mail info@ceramics.org; www.ceramics.org/meetings.

17-18 Plastics Additives and Compounding Conf. (Addcon World 2006), Cologne, Germany. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, United Kingdom, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/addcon06.

19-20 ▼ Intl. Activated Carbon Conf., Pittsburgh, PA. Henry Nowicki, PACS Testing and Consulting, 409 Meade Drive, Coraopolis, PA, 15108; 724-457-6576; fax 724-457-1214; e-mail hnpacs@aol.com; cbrunning.net/pacs/conferences/IACC/IACC18.htm.

22-27 ▼ Gordon Research Conf. on Biointerface Science, Les Diablerets, Switzerland. Ashutosh Chilkoti, Duke University, Dept. of Biomedical Engineering, Box 90281, Durham, NC, 27708-0281; e-mail chilkoti@duke.edu; www.grc.org/programs/2006/bioint.htm.

23-24 ▼ SPE Engineering Properties and Structure Division (TopCon 2006), Akron, OH. Society of Plastics Engineers, 14 Fairfield Drive, P.O. Box 403, Brookfield, CT 06804-0403; 203-775-0471, fax 203-775-8490; e-mail info@4spe.org; www.4spe.org/conf/eps-div06/0610epsdiv.php.

29-2 XI Intl. Conf. on the Physics of Non-Crystalline Solids, Rhodes, Greece. Vasso Zatta, Institute of Materials Science, NCSR "Demokritos" 1530 10 Aghia Paraskevi Attiki, Greece; 30-210-6503381; fax 30-210-6503323; e-mail vzatta@ims.demokritos.gr; web.ims.demokritos.gr/glass/XI-PNCS.

29-2 Control of Particulate Processes, Harrison Hot Springs, BC. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6av.html.

30-3 ▼ APS Annual DPP Meeting, Philadelphia, PA. APS, www.aps.org/meet/calendar.cfm.

NOVEMBER 2006

8-9 Thermoplastic Elastomers Conf. (TPE 2006), Munich, Germany. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, UK; 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/tpe06.

12-16 ISTFA Conf. and Exposition, Austin, TX. ASM International Customer Service, 9639 Kinsman Road, Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; e-mail customer.service@asminternational.org; www.asmiinternational.com

13-17 Fuel Cell Seminar 2006, Honolulu, HI. Fuel Cell Seminar Headquarters, c/o Courtesy Associates, 2025 M Street, Suite 800, Washington, DC, 20036; 202-973-8671; fax 202-331-0111; e-mail fuelcell@courtesyassoc.com; www.fuelcellseminar.com.

27-1 2006 MRS Fall Meeting, Boston, MA. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

DECEMBER 2006

4-5 Intl. Conf. Nanoinprint Lithography Application in Nanosystems and Nanodevices (NanoKAP 2006), Miami Beach, FL. Knowledge Foundation, 18 Webster Street, Brookline, MA, 02446-4938; (617) 232-7400; fax (617) 232-9171; e-mail custserv@knowledgefoundation.com; www.knowledgefoundation.com.

CALENDAR

5-6 Lithium Mobile Power 2006 - Conf. on Advances in Lithium Battery Technologies for Mobile Applications, *Miami Beach, FL*. Knowledge Foundation, 18 Webster Street, Brookline, MA, 02446-4938; (617) 232-7400; fax (617) 232-9171; e-mail custserv@knowledgefoundation.com; www.knowledgefoundation.com.

5-6 RubberChem 2006, *Munich, Germany*. Rapra Technology, 44-0-1939-250383; e-mail conferences@rapra.net; www.rapra.net/conferences/rubberchem06.

14-16 ▼ Flexible Packaging Conf. (FlexPackCon 2006), *Orlando, FL*. Society of Plastics Engineers, 14 Fairfield Drive, P.O. Box 403, Brookfield, CT 06804-0403; 203-775-0471, fax 203-775-8490; e-mail info@4spe.org; www.4spe.org/conf/flexpack06.

FEBRUARY 2007

20-23 Intl. Conf. on Recent Advances in Composite Materials (ICRACM), *New Delhi, India*. V.K. Srivastava, ICRACM-2007, Dept. of Mechanical Engineering, Institute of Technology, Banaras Hindu University, Varanasi-221005, India; 91-542-2368157; e-mail vijays_sa@yahoo.com; www.htu.ac.in/notification/icracm.htm.

25-1 2007 TMS Annual Meeting and Exhibition, *Orlando, FL*. TMS Meetings Services, 184 Thorn Hill Road, Warrendale, PA, 15086; 724-776-9000 x243; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/meetings/meetings.asp.

MARCH 2007

3-7 Biophysical Society Annual Meeting, *Baltimore, MD*. www.biophysical.org/meetings/future.htm.

5-9 ▼ APS March Meeting 2007, *Denver, CO*. APS, www.aps.org/meet/calendar.cfm.

19-22 Intl. Laser Safety Conf. (ILSC), *San Francisco, CA*. Laser Institute of America, 13501 Ingenuity Drive, Suite 128, Orlando, FL, 32826; 407-380-1553; fax 407-380-5588; e-mail bcohen@laserinstitute.org; www.laserinstitute.org/conferences/ilsc.

25-29 ACS National Meeting & Exposition, *Chicago, IL*. American Chemical Society, attn: National Expositions, 1155 Sixteenth Street, Washington, DC 20036; e-mail expo@acs.org; chemistry.org/expositions.

APRIL 2007

9-13 2007 MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Drive, Warrendale; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS**.

14-17 ▼ APS April Meeting 2007, *Jacksonville, FL*. APS, www.aps.org/meet/calendar.cfm.

28-2 ▼ Experimental Biology 2007 Annual Meeting, *Washington, DC*. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings.

MAY 2007

13-17 ▼ MPIF Intl. Conf. on Powder Metallurgy and Particulate Materials (PowderMet 2007), *Denver, CO*. MPIF, 105 College Road East, Princeton, NJ, 08540; 609-452-7700; fax 609-987-8523; e-mail info@mpif.org; www.mpif.org.

27-31 ▼ 10th Intl. Conf. on the Mechanical Behavior of Materials, *Seoul, Korea*. JC International, Twin Tower B #1008, 275-4 Yangjae-dong, Seocho-gu, 137-130 Seoul, Korea, 82-2-571-2724; fax 82-2-571-2721; e-mail jpcark@jcenter.co.kr; icm10.org.

JUNE 2007

5-9 ▼ APS Annual Division of Atomic, Molecular and Optical Physics Meeting, *Calgary, AB*. APS, www.aps.org/meet/calendar.cfm.

25-28 ECM VIII: Bone Tissue Engineering, *Davos, Switzerland*. Sonia Wahl, AO Research Institute, Clavadelerstrasse, CH-7270 Davos Platz, Davos, Switzerland, 41-81-41-42-541; fax 41-81-41-42-299; e-mail sonia.wahl@aofoundation.org; www.ecmjournal.org/ecm_meetings/next_event.shtml.

JULY 2007

2-6 Intl. Congress on Glass, *Strasbourg, France*. ICG 2007, CRIT Materiaux Alsace, 19 rue de Saint Junien, BP 23, F67305 Schiltigheim Cedex, France; 33-0-3-88-19-15-10; fax 33-0-3-88-19-15-14; e-mail info@icg2007.org; www.icg2007.org.

AUGUST 2007

6-9 Microscopy and Micro-analysis 2007, *Ft. Lauderdale, FL*. Microscopy/Marketing & Education, Inc., Meeting Management Microscopy & Microanalysis, 125 Parido Street, Suite 102, Springfield, MA, 01118-2130; 972-954-8011; fax 972-954-8018; e-mail corporate@mme1.com; microscopy.org/MMMeetings.

19-23 ACS National Meeting and Exposition, *Boston, MA*. American Chemical Society, ATTN: National Expositions, 1155 Sixteenth Street, Washington, DC 20036; e-mail expo@acs.org; chemistry.org/expositions.

OCTOBER 2007

8-13 Intl. Conf. on Advanced Materials (IUMRS-ICAM 2007), *Bangalore, India*. Secretariat IUMRS-ICAM-2007, Materials Research Society of India, Bangalore, India, 91-080-22932882; fax 91-080-23602028; e-mail secretariat@icam2007.com; www.icam2007.com. **IUMRS/MRS-I**.

NOVEMBER 2007

12-16 ▼ APS Annual DPP Meeting, *Orlando, FL*. APS, www.aps.org/meet/calendar.cfm.

26-30 2007 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Drive, Warrendale, 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; <http://www.mrs.org>. **MRS**.

MARCH 2008

10-14 ▼ APS March Meeting 2008, *New Orleans, LA*. APS, www.aps.org/meet/calendar.cfm.

24-28 2008 MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Drive, Warrendale, 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS**.

APRIL 2008

3-9 Experimental Biology 2008 Annual Meeting, *San Diego, CA*. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings.

12-15 ▼ APS April Meeting 2008, *St. Louis, MO*. APS, www.aps.org/meet/calendar.cfm.

MAY 2008

28-1 World Biomaterials Congress, *Amsterdam, Netherlands*. Secretariat World Biomaterials Congress, International Conference Services, P.O. Box 83005, 1080 AA, Amsterdam, Netherlands, 31-0-206793218; fax 31-0-206758236; e-mail info.wbc2008@ics-online.nl; www.wbc2008.com.

JUNE 2008

23-26 ECM IX Fifty Years of AO: Internal Fixation: From Research to the Clinics, *Davos, Switzerland*. Sonia Wahl, AO Research Institute, Clavadelerstrasse, CH-7270 Davos Platz, Davos, Switzerland, 41-81-41-42-541; fax 41-81-41-42-299; e-mail sonia.wahl@aofoundation.org; www.ecmjournal.org/ecm_meetings/next_event.shtml.

NOVEMBER 2008

17-21 ▼ APS Annual DPP Meeting, *Dallas, TX*. APS, www.aps.org/meet/calendar.cfm.

23-26 ECM IX Fifty Years of AO: Internal Fixation: From Research to the Clinics, *Davos, Switzerland*. Sonia Wahl, AO Research Institute, Clavadelerstrasse, CH-7270 Davos Platz, Davos, Switzerland, 41-81-41-42-541; fax 41-81-41-42-299; e-mail sonia.wahl@aofoundation.org; www.ecmjournal.org/ecm_meetings/next_event.shtml.

DECEMBER 2008

1-5 2008 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Drive, Warrendale, 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS**. □



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Location & Hours

Moscone West • Exhibit Hall (Level 1)

Monday, April 17 (Registration only).....	1:00 pm – 5:00 pm
Tuesday, April 18	11:00 am – 6:00 pm
Wednesday, April 19	11:00 am – 6:00 pm
Thursday, April 20	10:00 am – 1:00 pm